

Toshiba BiCD Process Integrated Circuit Silicon Monolithic

# TB67S179FTG

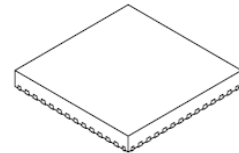
## Clock controlled 2-phase Unipolar stepping motor driver

The TB67S179FTG is a Clock controlled PWM chopping type 2-phase unipolar stepping motor driver. Using the BiCD process, the TB67S179FTG can be operated with VM voltage of 80V, output voltage of 80V, and output current of 1.5A at max (absolute maximum ratings).

### Features

- BiCD processed monolithic integrated circuit.
- Capable of operating one unipolar stepping motor.
- Full, half(a), half(b), quarter, 1/8, 1/16, 1/32 step resolution.
- PWM controlled synchronous rectification constant current drive.
- Reverse current protection function
- Error detect feedback signal output function (Over current/Thermal shutdown).
- Error detect function (Thermal shutdown(TSD), Over current(ISD), and Low voltage(POR).
- Standby mode (low power) function
- Brake function
- Low on resistance(0.5Ω (Typ.) output MOSFET.
- High voltage and current (For specification, please refer to the absolute maximum ratings and operation ranges).
- Build-in VCC regulator for internal circuit use.
- Fixed off time can be adjusted by external components.

Note: Please be careful about the thermal conditions during use.

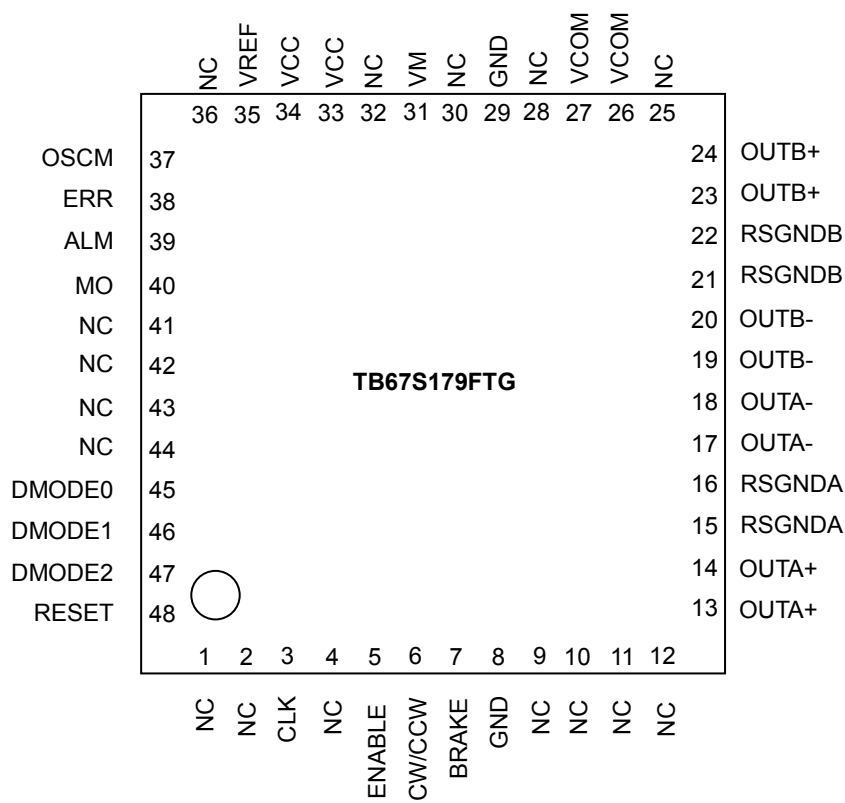
**FTG**

P-VQFN48-0707-0.50-004

Weight 0.14 (g) (typ.)

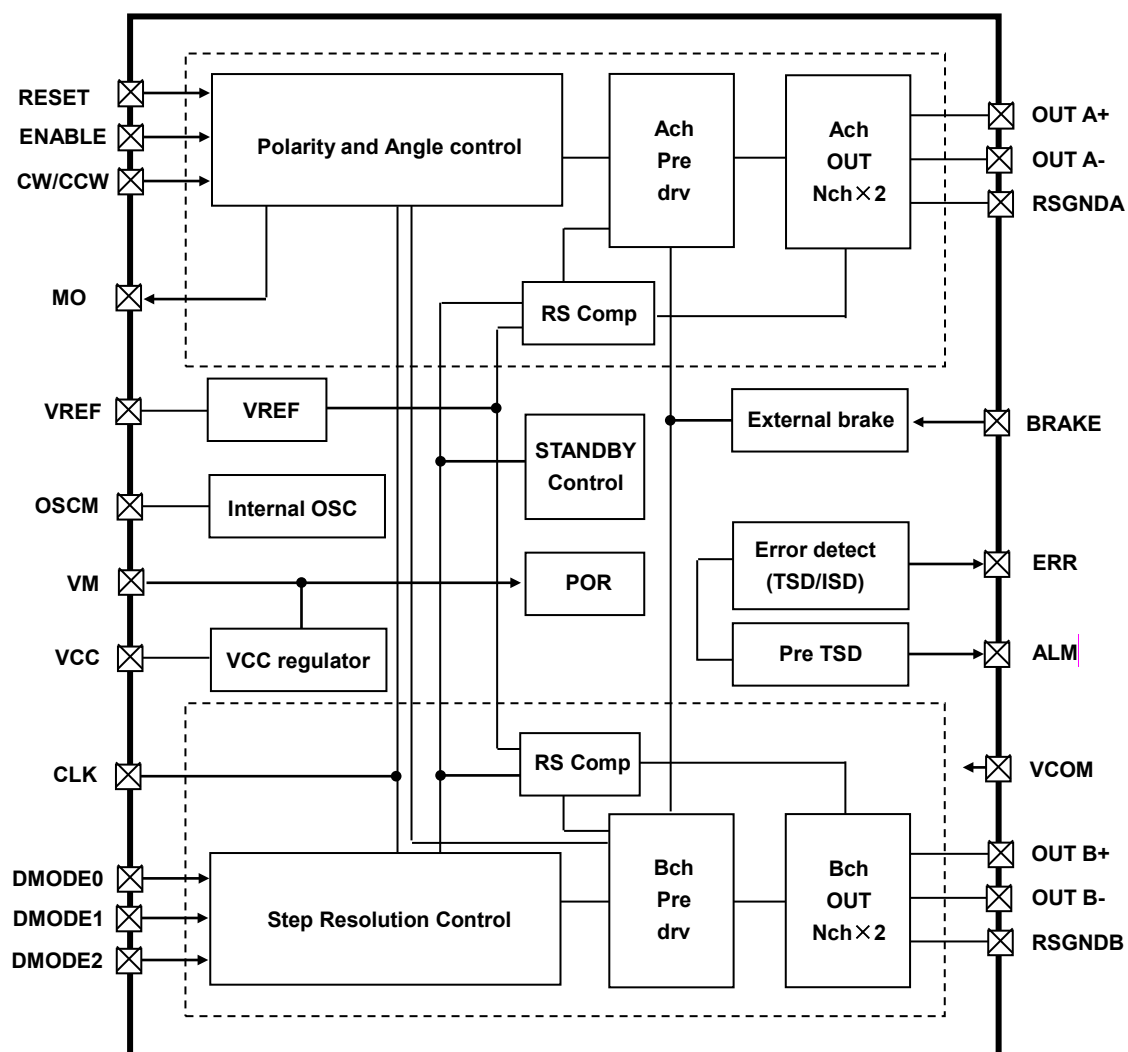
Pin assign (TB67S179FTG)

(Top View)



\* Please mount the four corner pins of the VQFN package and the exposed pad to the GND area of the PCB.

## TB67S179 block diagram



Functional blocks/circuits/constants in the block chart etc. may be omitted or simplified for explanatory purposes.

**Application Notes**

All the grounding wires of the device must run on the solder mask on the PCB and be externally terminated at only one point. Also, a grounding method should be considered for efficient heat dissipation.

Careful attention should be paid to the layout of the output, VDD (VM) and GND traces, to avoid short circuits across output pins or to the power supply or ground. If such a short circuit occurs, the device may be permanently damaged.

Also, the utmost care should be taken for pattern designing and implementation of the device since it has power supply pins (VM, RSGND, OUT, GND) through which a particularly large current may run. If these pins are wired incorrectly, an operation error may occur or the device may be destroyed.

The logic input pins must also be wired correctly. Otherwise, the device may be damaged owing to a current running through the IC that is larger than the specified current.

## Pin explanations

### TB67S179FTG (VQFN48)

Pin No.1 to 28

| Pin No. | Pin Name | Function                                  |
|---------|----------|-------------------------------------------|
| 1       | NC       | Non connection                            |
| 2       | NC       | Non connection                            |
| 3       | CLK      | External Clock input pin                  |
| 4       | NC       | Non connection                            |
| 5       | ENABLE   | Motor output ON/OFF pin                   |
| 6       | CW/CCW   | Clock-wise/Counter Clock-wise setting pin |
| 7       | BRAKE    | Brake input pin                           |
| 8       | GND      | Ground pin                                |
| 9       | NC       | Non connection                            |
| 10      | NC       | Non connection                            |
| 11      | NC       | Non connection                            |
| 12      | NC       | Non connection                            |
| 13      | OUTA+    | Motor output A+ pin                       |
| 14      | OUTA+    | Motor output A+ pin                       |
| 15      | RSGNDA   | Ach current sense ground pin              |
| 16      | RSGNDA   | Ach current sense ground pin              |
| 17      | OUTA-    | Motor output A-pin                        |
| 18      | OUTA-    | Motor output A-pin                        |
| 19      | OUTB-    | Motor output B-pin                        |
| 20      | OUTB-    | Motor output B-pin                        |
| 21      | RSGNDB   | Bch current sense ground pin              |
| 22      | RSGNDB   | Bch current sense ground pin              |
| 23      | OUTB+    | Motor output B+ pin                       |
| 24      | OUTB+    | Motor output B+ pin                       |
| 25      | NC       | Non connection                            |
| 26      | VCOM     | Common pin                                |
| 27      | VCOM     | Common pin                                |
| 28      | NC       | Non connection                            |

Pin No.29 to 48

| Pin No. | Pin Name | Function                                |
|---------|----------|-----------------------------------------|
| 29      | GND      | Ground pin                              |
| 30      | NC       | Non connection                          |
| 31      | VM       | VM power supply pin                     |
| 32      | NC       | Non connection                          |
| 33      | VCC      | Internal VCC regulator monitor pin      |
| 34      | VCC      | Internal VCC regulator monitor pin      |
| 35      | VREF     | Constant current threshold set pin      |
| 36      | NC       | Non connection                          |
| 37      | OSCM     | Fixed off time set pin                  |
| 38      | ERR      | Error detect feedback signal output pin |
| 39      | ALM      | Thermal alarm output pin                |
| 40      | MO       | Electrical angle monitor pin            |
| 41      | NC       | Non connection                          |
| 42      | NC       | Non connection                          |
| 43      | NC       | Non connection                          |
| 44      | NC       | Non connection                          |
| 45      | DMODE0   | Step setting pin 0                      |
| 46      | DMODE1   | Step setting pin 1                      |
| 47      | DMODE2   | Step setting pin 2                      |
| 48      | RESET    | Electrical angle reset pin              |

Note:

- Please do not run patterns under NC pins.
- Please connect the pins with the same pin name, while using the device.

## INPUT/OUTPUT Equivalent circuit

| Pin name                                                                | Input / Output                                                                                                                                                                    | Equivalent circuit |
|-------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------|
| DMODE0<br>DMODE1<br>DMODE2<br>CW/CCW<br>CLK<br>RESET<br>ENABLE<br>BRAKE | Logic input (VIH/VIL)<br><br>VIH: 2.0V(min) to 5.5V(max)<br>VIL : 0V(min) to 0.8V(max)                                                                                            |                    |
| ERR<br>ALM<br>MO                                                        | Logic output (VOH/VOL)<br><br>(Pullup resistance: 10kΩ to 100kΩ)                                                                                                                  |                    |
| VCC<br><br><br>VREF                                                     | VCC voltage range<br>4.75V(min) to 5.0V(Typ.) to 5.25V(max)<br><br>VREF input voltage range<br>0V to 2.0V (Constant current control)<br>VCC short (Constant current control: OFF) |                    |
| OSCM                                                                    | OSCM frequency setup (reference)<br>0.8MHz(min) to 3.2MHz(Typ.) to 8.2MHz(max)<br><br>(R_OSCM=3.9kΩ to 10kΩ to 39kΩ)                                                              |                    |
| OUT A+<br>OUT A-<br>OUT B+<br>OUT B-<br>RSGNDA<br>RSGNDB<br>VCOM        | VM voltage range<br>10V(min) to 60V(max)<br><br>OUT pin voltage range<br>10V(min) to 80V(max)                                                                                     |                    |

The equivalent circuit diagrams may be simplified or some parts of them may be omitted for explanatory purposes.

**TB67S179 function explanation****CLK function**

The CLK pin controls the rotation speed of the motor. Each CLK signal will shift the motor's electrical angle per step, due to each up-edge of the CLK signal.

| CLK             | Function                                           |
|-----------------|----------------------------------------------------|
| ↑ (Low to High) | Shifts the electrical angle per step.              |
| ↓ (High to Low) | — (State of the electrical angle does not change.) |

**ENABLE function**

The ENABLE pin controls the ON and OFF of the corresponding output stage. For accurate operation, please set the ENABLE to Low during VM power-on and power-off sequence.

| ENABLE | Function                            |
|--------|-------------------------------------|
| High   | Motor output: ON (normal operation) |
| Low    | Motor output: OFF (high impedance)  |

**CW/CCW function**

The CW/CCW pin controls the rotation direction of the motor.

| CW/CCW | Function                 |
|--------|--------------------------|
| High   | Clock-wise (CW)          |
| Low    | Counter Clock-wise (CCW) |

When set to 'CW', the Ach current phase leads the Bch current phase by 90°.

When set to 'CCW', the Bch current phase leads the Ach current phase by 90°.



## RESET function

The RESET pin controls the reset of the internal electrical angle. For accurate operation, please set the RESET pin to 'High' during VM power-on. Switch the RESET to 'Low', once the VM voltage has reached the operation range.

| RESET | Function                                          |
|-------|---------------------------------------------------|
| High  | Sets the electrical angle to the initial position |
| Low   | Normal operation                                  |

The current setting for each channel while RESET is applied is shown in the table below.  
MO pin level will show 'Low' level at this time.

| Step resolution setting | Ach current | Bch current | Electrical angle to the initial position |
|-------------------------|-------------|-------------|------------------------------------------|
| Full step               | 100%        | 100%        | 45°                                      |
| Half step (a)           | 100%        | 100%        | 45°                                      |
| Quarter step            | 71%         | 71%         | 45°                                      |
| Half step (b)           | 71%         | 71%         | 45°                                      |
| 1/8 step                | 71%         | 71%         | 45°                                      |
| 1/16 step               | 71%         | 71%         | 45°                                      |
| 1/32 step               | 71%         | 71%         | 45°                                      |

## DMODE (Step resolution setting) function

The DMODE pin controls the Standby mode and the step resolution setting.

| DMODE0 | DMODE1 | DMODE2 | Function                                                                                                                                         |
|--------|--------|--------|--------------------------------------------------------------------------------------------------------------------------------------------------|
| Low    | Low    | Low    | Standby mode (The internal oscillator is disabled and the motor output is set to 'OFF' status. The internal status is Full step, Torque100% (*)) |
| Low    | Low    | High   | Full step                                                                                                                                        |
| Low    | High   | Low    | Half step(a)                                                                                                                                     |
| Low    | High   | High   | Quarter step                                                                                                                                     |
| High   | Low    | Low    | Half step(b)                                                                                                                                     |
| High   | Low    | High   | 1/8 step                                                                                                                                         |
| High   | High   | Low    | 1/16 step                                                                                                                                        |
| High   | High   | High   | 1/32 step                                                                                                                                        |

(\*) [Full step, Torque 100%] written above shows the initial status of the logic. (During Standby mode, the internal oscillator and motor output is set to OFF, therefore does not mean that the device will operate at [Full step, Torque 100%])

## Standby mode function

Setting all of the DMODE pins(DMODE0,DMODE1,and DMODE2) to Low will set the device to Standby mode. During Standby mode, the internal bias current is cut so that the device be set to low power mode. Also, setting the device to Standby mode will release the error detection such as TSD and ISD. Moreover, the electrical angle is initialized by setting the Standby mode.

| Standby mode                      | Function                             |
|-----------------------------------|--------------------------------------|
| ON (DMODE0,1,2=L,L,L)             | Standby mode: ON (Low power mode)    |
| OFF (other than DMODE0,1,2=L,L,L) | Standby mode: OFF (Normal operation) |

After the device detects an error such as TSD or ISD, setting the device to Standby mode to OFF and then ON again will release the error detect latch signal. (Reasserting the VM power will also release the error detect latch signal.)

In the Standby mode, the internal functions are suspended. Therefore, during the startup period (10 $\mu$ s after setting the Standby mode: OFF), please do not send any control signals. (If the signal is sent to the device during the startup period, the device may not be able to accept the signal correctly.)

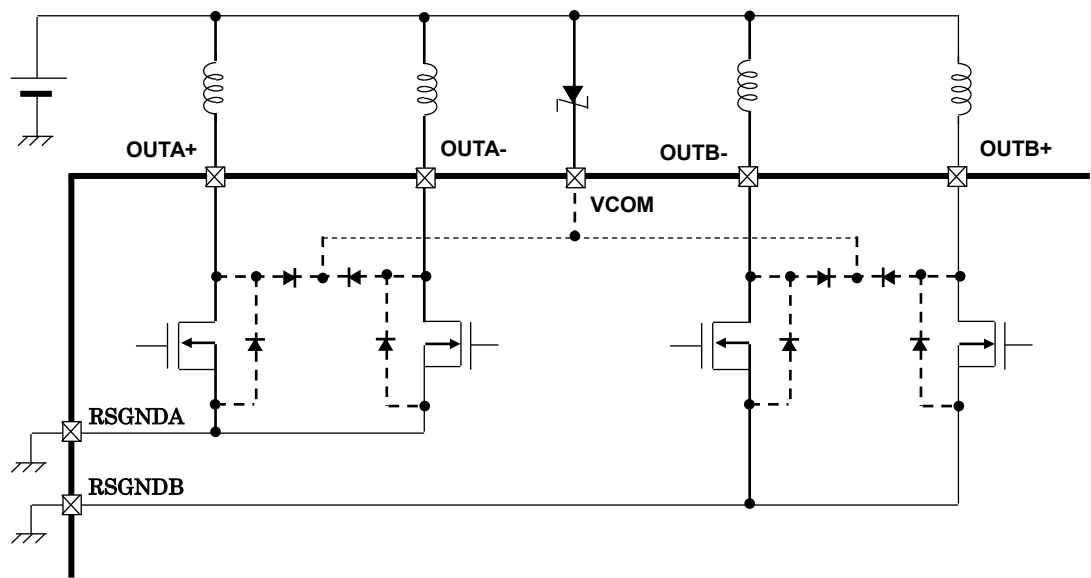
## Step resolution and current ratio

| Characteristics | Step resolution |          |          |         |     |      |      | Step | Typ. | Unit |
|-----------------|-----------------|----------|----------|---------|-----|------|------|------|------|------|
|                 | Full            | Half (a) | Half (b) | Quarter | 1/8 | 1/16 | 1/32 |      |      |      |
| Current Ratio   | ○               | ○        | ○        | ○       | ○   | ○    | ○    | θ32  | 100  | %    |
|                 | -               | -        | -        | -       | -   | -    | ○    | θ31  | 100  |      |
|                 |                 |          |          |         |     | ○    | ○    | θ30  | 100  |      |
|                 |                 |          |          |         |     | -    | ○    | θ29  | 99   |      |
|                 |                 |          |          |         | ○   | ○    | ○    | θ28  | 98   |      |
|                 |                 |          |          |         | -   | -    | ○    | θ27  | 97   |      |
|                 |                 |          |          |         |     | ○    | ○    | θ26  | 96   |      |
|                 |                 |          |          |         |     | -    | ○    | θ25  | 94   |      |
|                 |                 |          |          | (*2)    | ○   | ○    | ○    | θ24  | 92   |      |
|                 |                 |          |          | -       | -   | -    | ○    | θ23  | 90   |      |
|                 |                 |          |          |         |     | ○    | ○    | θ22  | 88   |      |
|                 |                 |          |          |         |     | -    | ○    | θ21  | 86   |      |
|                 |                 |          |          |         | ○   | ○    | ○    | θ20  | 83   |      |
|                 |                 |          |          |         | -   | -    | ○    | θ19  | 80   |      |
|                 |                 |          |          |         |     | ○    | ○    | θ18  | 77   |      |
|                 |                 |          |          |         |     | -    | ○    | θ17  | 74   |      |
|                 |                 |          |          |         |     | -    | ○    | θ16  | 71   |      |
|                 |                 | (*1)     | ○        | ○       | ○   | ○    | ○    | θ15  | 67   |      |
|                 |                 | -        | -        | -       | -   | -    | ○    | θ14  | 63   |      |
|                 |                 |          |          |         |     | -    | ○    | θ13  | 60   |      |
|                 |                 |          |          |         |     | ○    | ○    | θ12  | 56   |      |
|                 |                 |          |          |         | -   | -    | ○    | θ11  | 52   |      |
|                 |                 |          |          |         |     | ○    | ○    | θ10  | 47   |      |
|                 |                 |          |          |         |     | -    | ○    | θ9   | 43   |      |
|                 |                 |          |          |         | ○   | ○    | ○    | θ8   | 38   |      |
|                 |                 |          |          | -       | -   | -    | ○    | θ7   | 34   |      |
|                 |                 |          |          |         |     | ○    | ○    | θ6   | 29   |      |
|                 |                 |          |          |         |     | -    | ○    | θ5   | 25   |      |
|                 |                 |          |          |         | ○   | ○    | ○    | θ4   | 20   |      |
|                 |                 |          |          |         | -   | -    | ○    | θ3   | 15   |      |
|                 |                 |          |          |         |     | ○    | ○    | θ2   | 10   |      |
|                 |                 |          |          |         |     | -    | ○    | θ1   | 5    |      |
|                 |                 | ○        | ○        | ○       | ○   | ○    | ○    | θ0   | 0    |      |

(\*1) At Half (a) setting, the current ratio will be 100%.

(\*2) At Quarter setting, the current ratio will be 100%.

BRAKE mode function



Equivalent circuit(s) may be omitted for explanatory purpose.

| BRAKE | Function                           |
|-------|------------------------------------|
| H     | Brake mode: ON                     |
| L     | Brake mode: OFF (Normal operation) |

The brake function is changed according to the control setting (of the constant current or the constant voltage).

•During Constant current control:  $V_{REF} \leq 2.0V$

When BRAKE is set to H, the constant current operation is performed with the current of 100% setting value, regardless of the current setting value then.

| Internal current setting when BRAKE is set to H from L. | Setting value of constant current when BRAKE is set to H. |
|---------------------------------------------------------|-----------------------------------------------------------|
| IOUT= 0% to +100%                                       | +100%                                                     |
| IOUT= 0% to -100%                                       | -100%                                                     |

- \* The IOUT in the above table is indicated as plus current when OUT+ turns on, and as minus current when OUT- turns on, at the time of Charge.
- \* When the CLK signal is input during BRAKE=H, the internal current setting status is advanced ordinarily.

•During Constant voltage control:  $V_{REF}$ -VCC direct connected

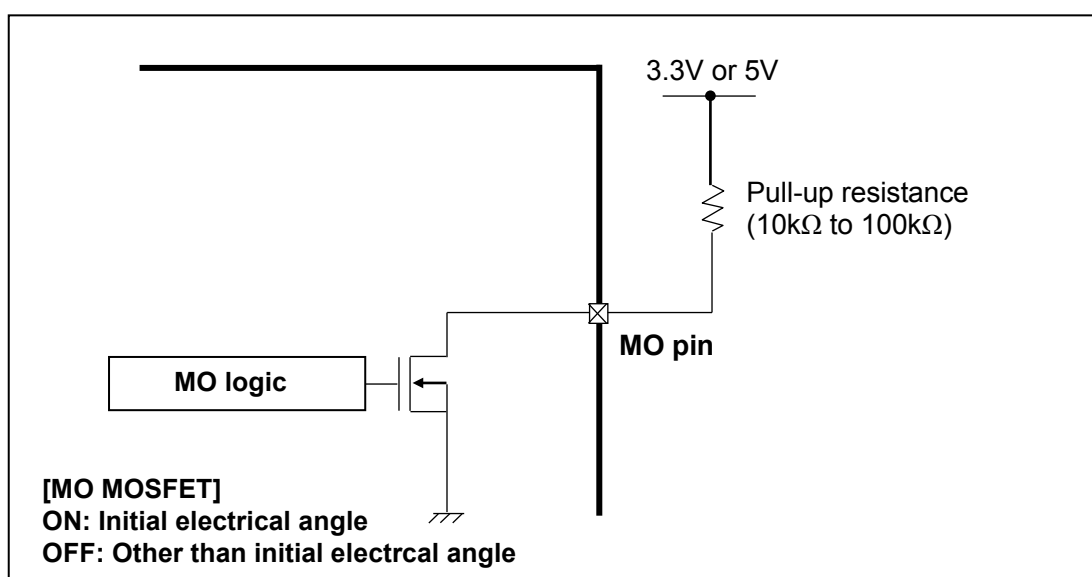
When BRAKE is set to H, the motor output becomes the full step resolution (OUTA+, OUTA-, OUTB+, and OUTB-: ON).

- \* Make sure to connect the VREF pin and VCC pin directly without using the external power supply in the constant voltage mode.

**MO pin functions (MO feedback)**

| MO pin   | Function                                |
|----------|-----------------------------------------|
| Hi-Z (*) | — (Other than initial electrical angle) |
| Low      | Initial electrical angle                |

(\*) MO pin is an open drain logic output. To use the function correctly, please make sure the MO pin is connected to 3.3V or 5.0V with a pull-up resistance. If the internal electrical angle is at the initial angle, the pin level will be Low (internal MOSFET: ON). If the internal electrical angle is not at the initial angle, the pin level will be Hi-Z (internal MOSFET: OFF) (it will show High level when pulled up correctly). Please refer to the 'RESET function' for the initial angle. MO pin should be left open; when not using the MO feedback function.

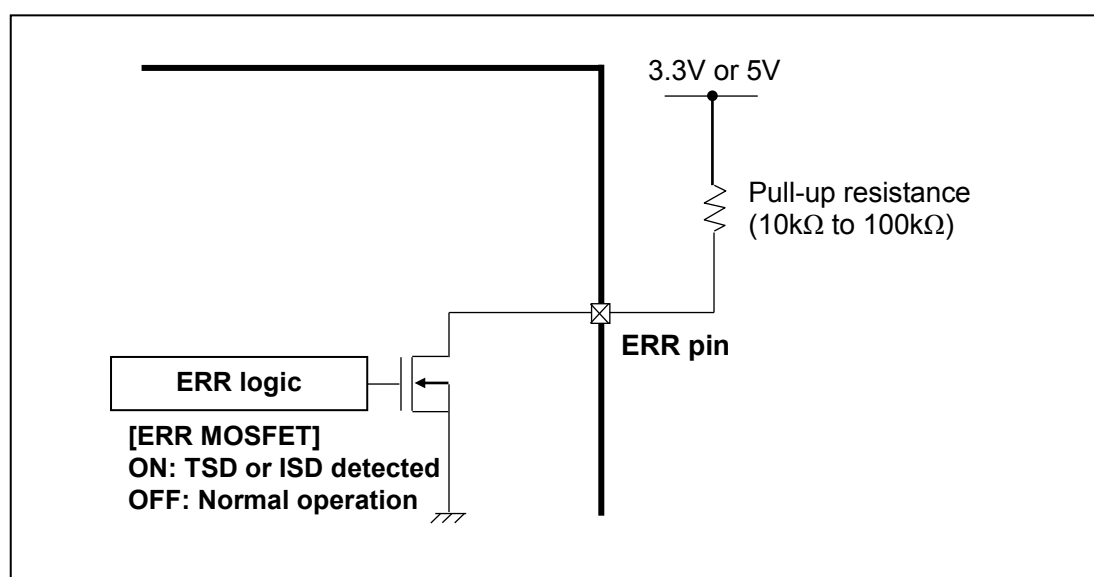


Equivalent circuit(s) may be omitted for explanatory purpose.

## ERR pin functions (ERR feedback)

| ERR pin  | Function                    |
|----------|-----------------------------|
| Hi-Z (*) | Normal operation            |
| Low      | Error detected (TSD or ISD) |

(\*) The ERR pin is an open drain logic output. To use this function correctly, please make sure the ERR pin is connected to 3.3V or 5.0V with a pull-up resistance. During normal operation, the pin level will be Hi-Z (internal MOSFET: OFF) (it will show High level when pulled up), and once an error (TSD or ISD) has been detected, the pin level will be Low (internal MOSFET: ON). Reasserting the VM power supply or using the STBY function, the ERR pin will return to the initial status (internal MOSFET: OFF). ERR pin should be left open; when not using the ERR feedback function.

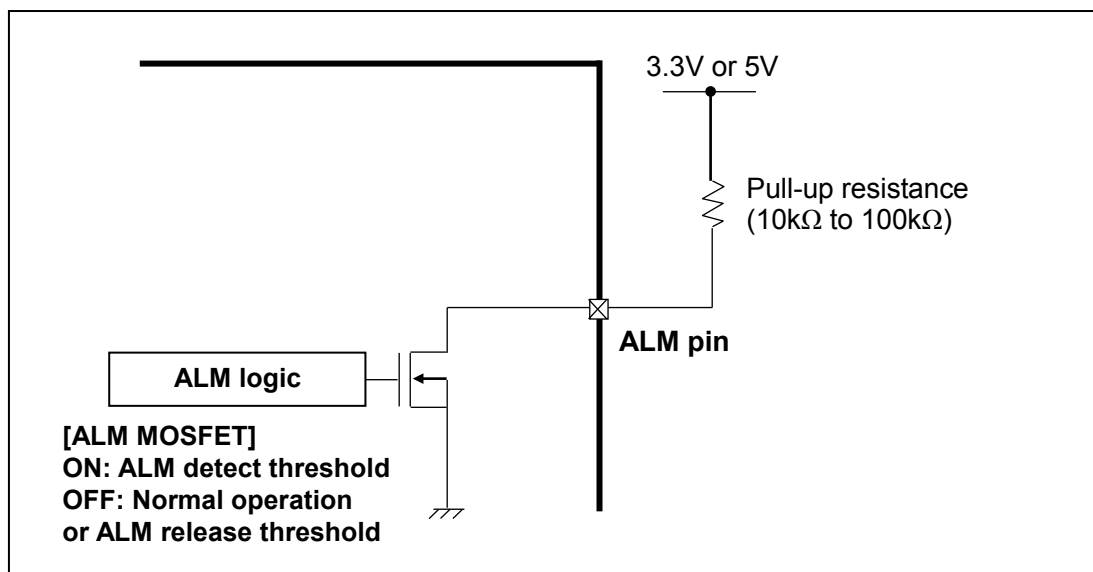
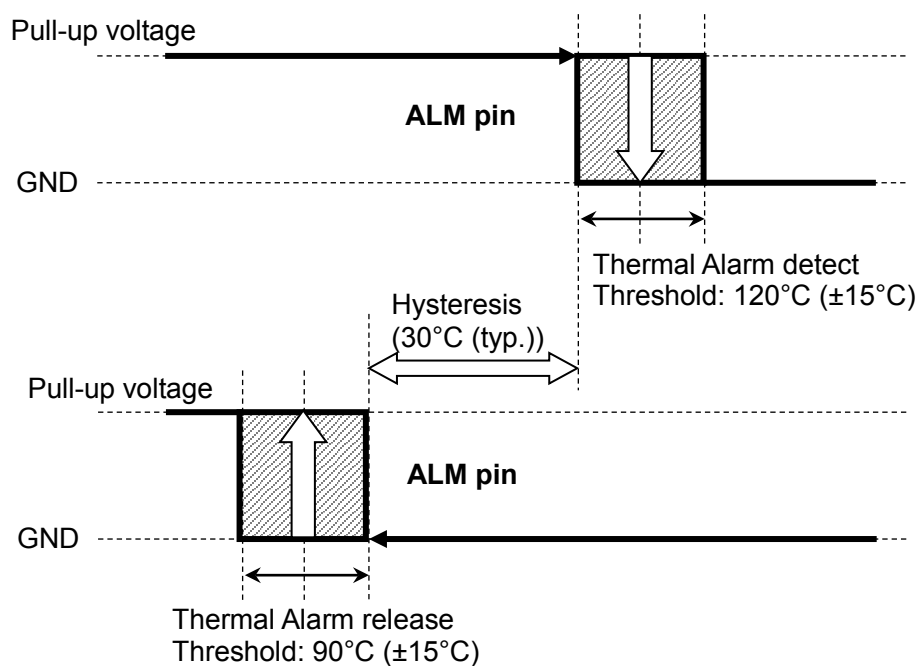


Equivalent circuit(s) may be omitted for explanatory purpose.

## ALM pin functions (Thermal ALM feedback)

| ALM pin  | Function               |
|----------|------------------------|
| Hi-Z (*) | Normal operation       |
| Low      | Thermal Alarm detected |

(\*)The ALM pin is an open drain logic output. To use the function correctly, please make sure the ALM pin is connected to 3.3V or 5.0V with a pull-up resistance. During normal operation, the pin level will be Hi-Z (internal MOSFET: OFF) (it will show High level when pulled up), and once the device detects a temperature rise, the pin level will be Low (internal MOSFET: ON). The ALM is an auto recovery type output. Once the device reaches the ALM detect threshold ( $120^{\circ}\text{C} \pm 15^{\circ}\text{C}$ ), the pin level will show Low (internal MOSFET: ON), and after the device reaches the ALM release threshold ('detect threshold' -  $30^{\circ}\text{C}$ ), the pin level will show Hi-Z (internal MOSFET: OFF) (it will show High level when pulled up). ALM pin should be left open; when not using the thermal ALM feedback function.



Equivalent circuit(s) may be omitted for explanatory purpose.

## TB67S179 setup

### Constant-current threshold setting

The constant-current threshold can be set by asserting the VREF voltage.

$$I_{OUT} = V_{REF} \times 3/4 \times I_{OUT}(\text{RATIO})$$

Example: Current setting 100%, VREF=2.0V: The constant current threshold (peak current) will be as shown below.

$$I_{OUT} = 2.0 \times 3/4 \times 1.0 = 1.5A$$

To set the constant-current function 'off', connect the VCC and VREF pin directly (do not use any external power supply).

### Fixed off time setting

To set the fixed off time for constant-current PWM control, please connect a pull-down resistance to the OSCM pin. The relation between the pull-down resistance (ROSCM) and fixed off time is as shown below.

| Operation mode        | Pull-down resistance (ROSCM) | Fixed off time (toff (Typ.)) | Note                                          |
|-----------------------|------------------------------|------------------------------|-----------------------------------------------|
| Constant-current mode | 3.9kΩ                        | 4.1μs                        | Electric characteristics [fOSCM1] prescribes. |
|                       | 4.7kΩ                        | 4.9μs                        |                                               |
|                       | 5.6kΩ                        | 5.8μs                        |                                               |
|                       | 6.8kΩ                        | 7.0μs                        |                                               |
|                       | 8.2kΩ                        | 8.3μs                        |                                               |
|                       | 10kΩ                         | 10μs                         |                                               |
|                       | 15kΩ                         | 15μs                         |                                               |
|                       | 18kΩ                         | 18μs                         |                                               |
|                       | 22kΩ                         | 21μs                         |                                               |
|                       | 27kΩ                         | 26μs                         |                                               |
|                       | 39kΩ                         | 37μs                         |                                               |
|                       | Open                         | 10μs                         | Electric characteristics [fOSCM2] prescribes. |
| Constant-voltage mode | (GND short: GND)<br>open     | -                            | Stops the internal oscillator.                |

The value shown in the table above does not include any dispersion of the device / external components.



**Absolute maximum ratings (Ta=25°C)**

| Characteristics                                   | Symbol      | Rating     | Unit |
|---------------------------------------------------|-------------|------------|------|
| Motor power supply                                | VM          | 80         | V    |
| VM-VCOM voltage differential                      | VDIFF       | 70         | V    |
| Motor output voltage                              | VOUT        | 80         | V    |
| Motor output current (per channel)                | IOUT        | 1.5        | A    |
| Internal logic power supply                       | VCC         | 6.0        | V    |
| Logic input voltage                               | VIN(H)(max) | 6.0        | V    |
|                                                   | VIN(L)(min) | -0.4       | V    |
| VREF input voltage                                | VREF        | 6.0        | V    |
| Open drain output pin (ERR,ALM,MO) voltage        | VOD         | 6.0        | V    |
| Open drain output pin (ERR,ALM,MO) inflow current | IOD         | 20         | mA   |
| Power dissipation (VQFN48; device alone)          | PD          | 1.3        | W    |
| Operating temperature                             | Topr        | -20 to 85  | °C   |
| Storage temperature                               | Tstg        | -55 to 150 | °C   |
| Junction temperature                              | Tj          | 150        | °C   |

**Caution) Absolute maximum ratings**

The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded, even for a moment. Do not exceed any of these ratings.

Exceeding the rating (s) may cause device breakdown, damage or deterioration, and may result in injury by explosion or combustion.

The value of even one parameter of the absolute maximum ratings should not be exceeded under any circumstances. The device does not have overvoltage detection circuit. Therefore, the device is damaged if a voltage exceeding its rated maximum is applied.

All voltage ratings, including supply voltages, must always be followed. The other notes and considerations described later should also be referred to.

Note: Allowable power dissipation

When Ta exceeds 25°C, the derating at 10.4 mW/°C is required.

## Operation ranges

| Characteristics                               | Symbol        | Test condition                                                   | Min  | Typ. | Max  | Unit |
|-----------------------------------------------|---------------|------------------------------------------------------------------|------|------|------|------|
| Motor power supply                            | VM            | -                                                                | 10   | -    | 60   | V    |
| Motor output voltage                          | VOOUT         | -                                                                | 10   | -    | 80   | V    |
| Motor output current (per channel)            | IOOUT         | Ta=25°C                                                          | -    | 1.0  | 1.5  | A    |
| Internal logic power supply                   | VCC           | -                                                                | 4.75 | 5.0  | 5.25 | V    |
| Logic input voltage                           | VIN(H)        | Logic input High level                                           | 2.0  | -    | 5.5  | V    |
|                                               | VIN(L)        | Logic input Low level                                            | 0    | -    | 0.8  | V    |
| Voltage range of VREF input pin               | VREF(range)1  | Constant-current mode                                            | GND  | -    | 2.0  | V    |
|                                               | VREF(Vrange)2 | Constant-voltage mode<br>Connected between VREF and VCC directly | -    | VCC  | -    | V    |
| Pull-up voltage range of open drain pin       | VOD(range)    | ERR,ALM,MO pin                                                   | 3.0  | -    | 5.5  | V    |
| Inflow current range of open drain output pin | IOD(range)    | ERR,ALM,MO pin                                                   | -    | -    | 10   | mA   |
| Motor setting frequency range                 | fOSCM1(range) | -                                                                | 820  | 3200 | 8200 | kHz  |
| Fixed off time range                          | tOFF(range)   | -                                                                | 5    | 10   | 40   | μs   |

Note: Maximum current for actual usage may be limited by the operating circumstances such as operating conditions (exciting mode, operating time, and so on), ambient temperature, and heat conditions (board condition and so on).

**DC Electrical Specifications 1 (Ta = 25°C, VM = 24 V, unless specified otherwise)**

| Characteristics                       |      | Symbol    | Test condition                                            | Min | Typ. | Max  | Unit |
|---------------------------------------|------|-----------|-----------------------------------------------------------|-----|------|------|------|
| Logic input voltage                   |      | VIH       | Logic input pin High level (*)                            | 2.0 | -    | 5.5  | V    |
|                                       |      | VIL       | Logic input pin Low level (*)                             | GND | -    | 0.8  | V    |
| Logic input hysteresis voltage        |      | VIN(HYS)  | Logic input pin (*)                                       | 100 | -    | 300  | mV   |
| Logic input current                   | High | IIN(H)    | Logic input voltage High level (VIN=VIH)                  | -   | 33   | 55   | μs   |
|                                       | Low  | IIN(L)    | Logic input voltage Low level (VIN=VIL)                   | -   | -    | 1    | μA   |
| Power consumption                     |      | IM1       | Output pins: open, Standby mode                           | -   | -    | 1.0  | mA   |
|                                       |      | IM2       | Output pins: open, Normal operation, Full step resolution | -   | 3.0  | 5.0  | mA   |
| Open drain output pin voltage         |      | VOD(L)    | IOD=10mA                                                  | 0   | -    | 0.5  | V    |
| Motor current setting differential    |      | ΔIOUT1    | Current differential between channels (IOUT=1.0A)         | -5  | 0    | +5   | %    |
| Motor current setting accuracy        |      | ΔIOUT2    | IOUT=1.0A                                                 | -6  | 0    | +6   | %    |
| Source-drain diode forward voltage    |      | VFN       | IOUT=1.5A                                                 | 1.0 | -    | 1.6  | V    |
| Motor output off leak current         |      | Ileak     | VOUT=80V, Output MOSFET:OFF                               | -   | -    | 1    | μA   |
| Motor output ON-resistance (Low side) |      | RON (D-S) | IOUT=1.5A                                                 | -   | 0.5  | 0.65 | Ω    |

(\*)VIN (H) is defined as the VIN voltage that causes the outputs (OUTA, OUTB) to change when a pin under test is gradually raised from 0 V. VIN (L) is defined as the VIN voltage that causes the outputs (OUTA and OUTB) to change when the pin is then gradually lowered. The difference between VIN (L) and VIN (H) is defined as VIN (HYS).

## DC Electrical Specifications 2 (Ta =25°C, VM = 24 V, unless specified otherwise)

| Characteristics                            | Symbol | Test condition  | Min  | Typ. | Max  | Unit |
|--------------------------------------------|--------|-----------------|------|------|------|------|
| VCC regulator voltage                      | VCC    | ICC=5.0mA       | 4.75 | 5.0  | 5.25 | V    |
| VCC regulator current                      | ICC    | 4.75V≤VCC≤5.25V | -    | 2.5  | 5.0  | mA   |
| VREF input current                         | IREF   | VREF=2.0V       | -    | 0    | 1.0  | μA   |
| Thermal shutdown (TSD) threshold (*)       | TjTSD  | -               | 140  | 155  | 170  | °C   |
| VCC recovery voltage                       | VCCR   | -               | 3.5  | 4.0  | 4.5  | V    |
| VM recovery voltage                        | VMR    | -               | 7.0  | 8.0  | 9.0  | V    |
| Over-current detection (ISD) threshold (*) | ISD    | -               | 2.1  | 3.0  | 4.0  | A    |

### (\*) About Thermal shutdown (TSD)

When the junction temperature of the device reached the TSD threshold, the TSD circuit is triggered; the internal reset circuit then turns off the output stage. Noise rejection blanking time is built-in to avoid misdetection by the switching and so on.

Once the TSD circuit is triggered; the detect latch signal can be cleared by reasserting the VM power source, or setting the device to standby mode. The TSD circuit is a backup function to detect a thermal error, therefore is not recommended to be used aggressively.

### (\*) About Over-current detection (ISD)

When the output current reaches the threshold, the ISD circuit is triggered; the internal reset circuit then turns off the output stage. The masking time is built in the IC to avoid misdetection by the switching and so on. Once the ISD circuit is triggered, the detect latch signal can be cleared by reasserting the VM power source, or setting the device to standby mode. The ISD function is a function to detect that the over-current flows into the motor output, therefore, is not recommended to be used aggressively.

## Back-EMF

While a motor is rotating, there is a timing at which power is fed back to the power supply. At that timing, the motor current recirculates back to the power supply due to the effect of the motor back-EMF.

If the power supply does not have enough sink capability, the power supply and output pins of the device might rise above the rated voltages. The magnitude of the motor back-EMF varies with usage conditions and motor characteristics. It must be fully verified that there is no risk that the device or other components will be damaged or fail due to the motor back-EMF.

## Cautions on Overcurrent Shutdown (ISD) and Thermal Shutdown (TSD)

The ISD and TSD circuits are only intended to provide temporary protection against irregular conditions such as an output short-circuits; they do not necessarily guarantee the complete IC safety.

If the device is used beyond the specified operating ranges, these circuits may not operate properly: then the device may be damaged due to an output short-circuit.

The ISD circuit is only intended to provide a temporary protection against an output short-circuit. If such condition persists for a long time, the device may be damaged due to overstress. Overcurrent conditions must be removed immediately by external hardware.

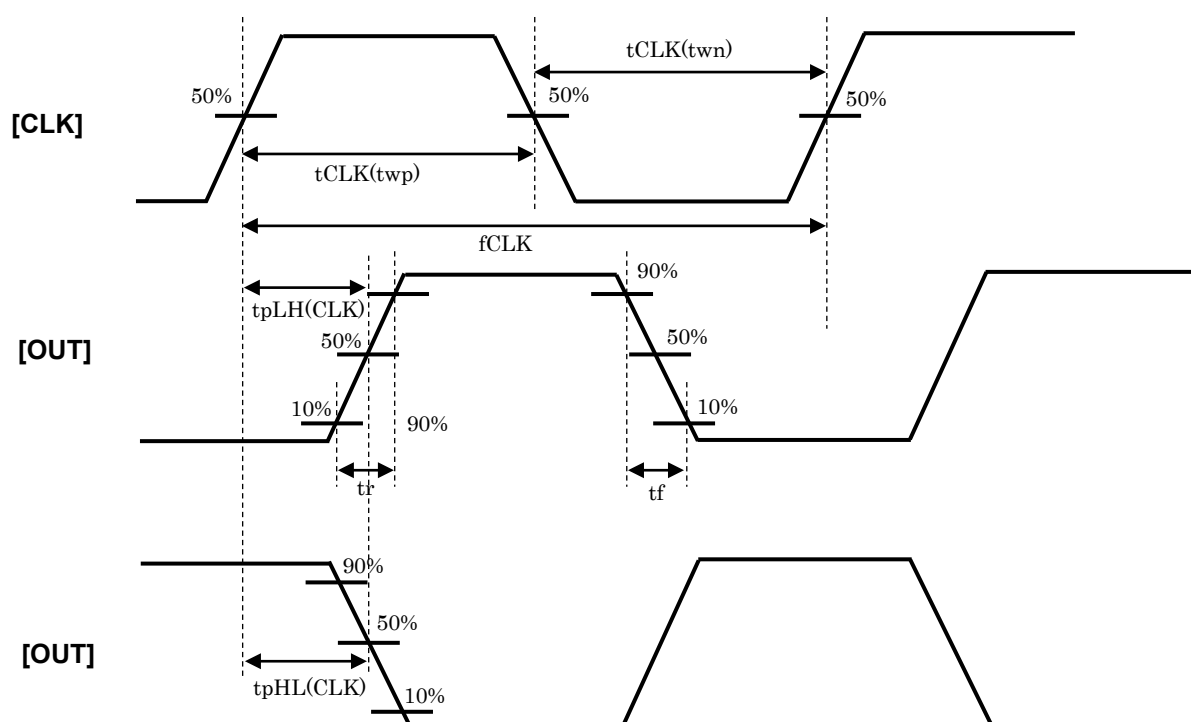
## IC Mounting

Do not insert devices incorrectly or in the wrong orientation. Otherwise, it may cause breakdown, damage and/or deterioration of the device.

## AC Electrical Specifications (Ta=25°C, VM=24V, unless specified otherwise)

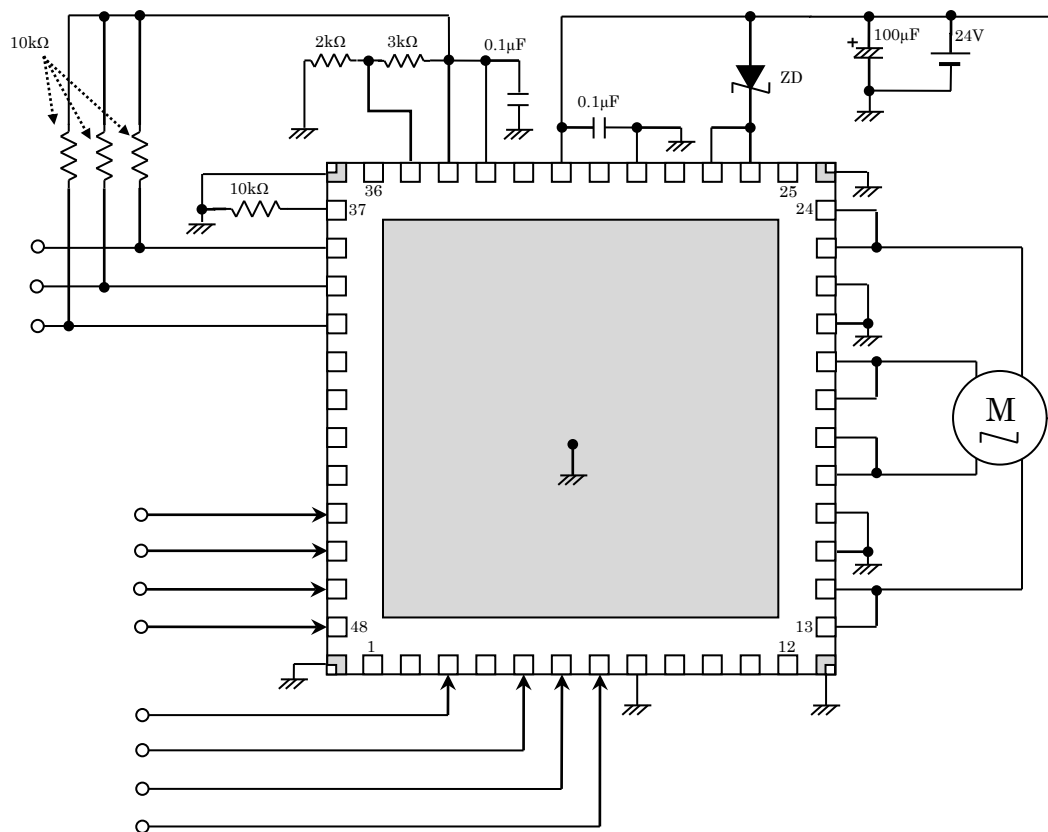
| Characteristics                            | Symbol     | Test condition       | Min | Typ. | Max  | Unit |
|--------------------------------------------|------------|----------------------|-----|------|------|------|
| CLK input frequency                        | fCLK       | fOSCM=3200kHz        | -   | -    | 100  | kHz  |
| Minimum CLK pulse width                    | tCLK(twp)  | -                    | 50  | -    | -    | ns   |
|                                            | tCLK(twn)  | -                    | 50  | -    | -    | ns   |
| Output MOSFET switching specification      | tr         | -                    | 50  | 100  | 150  | ns   |
|                                            | tf         | -                    | 50  | 100  | 150  | ns   |
| Output MOSFET response specification       | tpLH(CLK)  | CLK→OUT              | 200 | 700  | 1200 | ns   |
|                                            | tpHL(CLK)  | CLK→OUT              | 200 | 700  | 1200 | ns   |
| Analog noise blanking time                 | AtBLK      | Analog tblank time   | 250 | 400  | 550  | ns   |
| OSCM frequency tolerance                   | fOSCM1     | ROSC=10kΩ            | -15 | 0    | +15  | %    |
|                                            | fOSCM2     | ROSC=Open            | -20 | -    | +20  | %    |
| OSCS frequency tolerance                   | fOSCS      | -                    | -20 | 0    | +20  | %    |
| Fixed OFF time                             | tOFF       | fOSCM=3.2MHz         | 8.5 | 10   | 11.5 | μs   |
| Over current (ISD) detect masking time     | tISD(mask) | fOSCS=(6.4MHz)*8clk  | 1.0 | 1.25 | 1.5  | μs   |
| Thermal shutdown (TSD) detect masking time | tTSD(mask) | fOSCS=(6.4MHz)*32clk | 4.0 | 5.0  | 6.0  | μs   |
| Thermal Alarm (ALM) detect masking time    | tALM(mask) | fOSCS=(6.4MHz)*16clk | 2.0 | 2.5  | 3.0  | μs   |

## AC specification timing chart



Timing charts may be simplified for explanatory purpose.

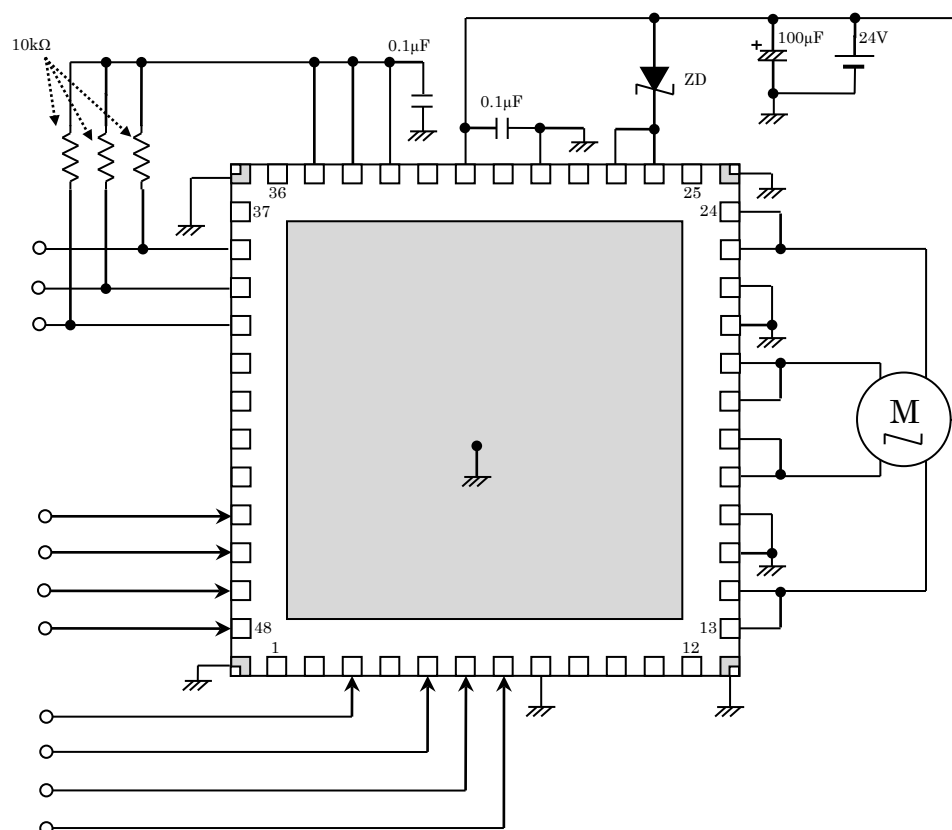
## Application circuit example (Constant current control)



\* Please mount the four corner pins of the VQFN package and the exposed pad to the GND area of the PCB.

The application circuit above is an example; therefore, mass-production design is not guaranteed.

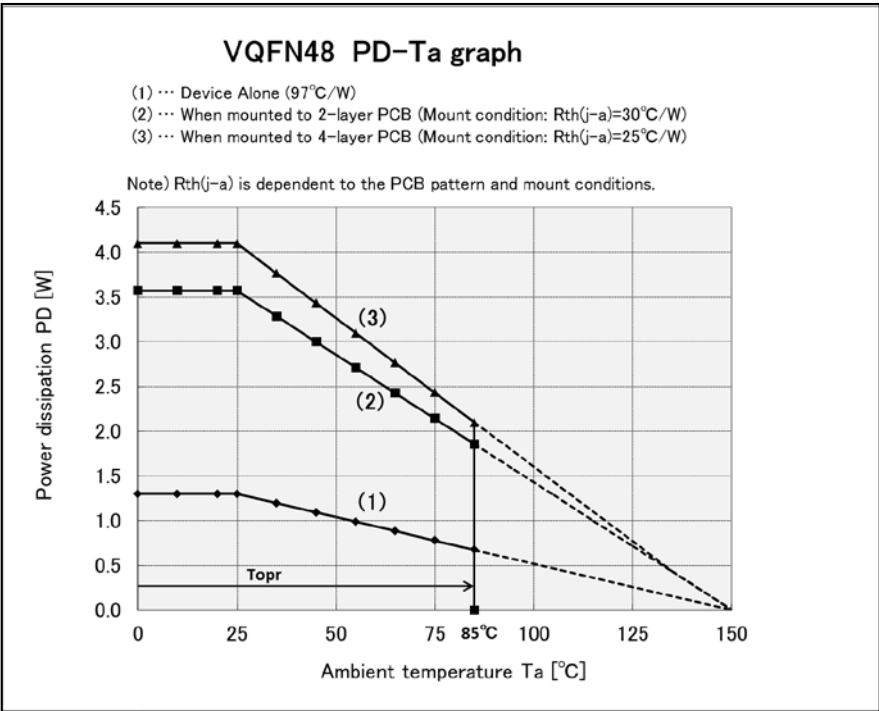
## Application circuit example (Constant voltage control)



\* Please mount the four corner pins of the VQFN package and the exposed pad to the GND area of the PCB.

The application circuit above is an example; therefore, mass-production design is not guaranteed.

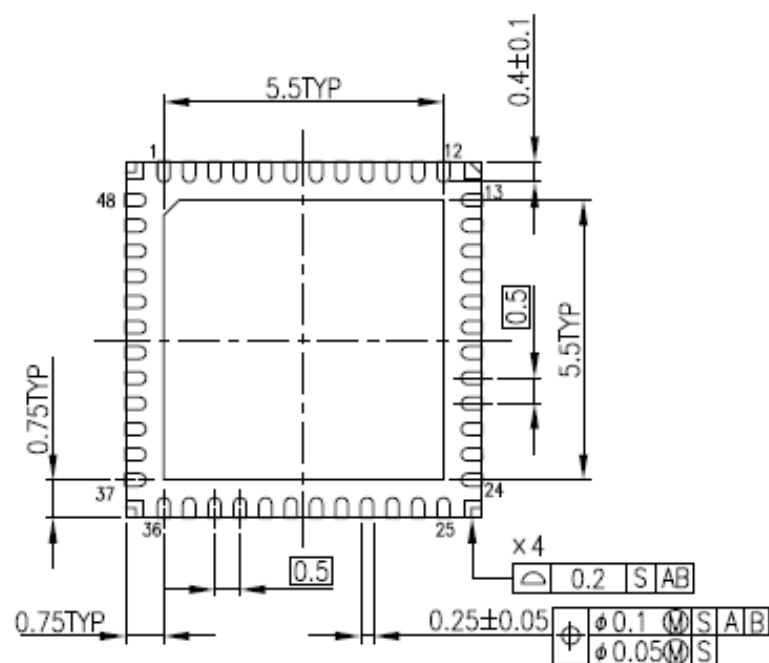
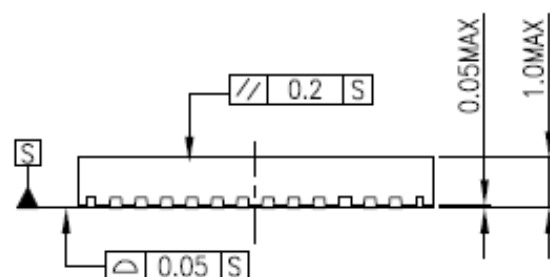
(For reference) PD-Ta graph



Note that  $T_a$ ,  $R_{\text{th(j-a)}}$ , and  $P_{\text{total}}$  are dependent on the usage environment.  
Moreover, when ambient environment temperature is high, permissible power consumption is reduced accordingly.

Other reference value:  $T(j-c)=3.5^{\circ}\text{C}/\text{W}$  of the VQFN48 package





2015-11-26

**Notes on Contents****1. Block Diagram**

Some of the functional blocks, circuits, or constants in the block diagram may be omitted or simplified for explanatory purposes.

**2. Equivalent Circuits**

The equivalent circuit diagrams may be simplified or some parts of them may be omitted for explanatory purposes.

**3. Timing Charts**

Timing charts may be simplified for explanatory purposes.

**4. Application Circuits**

The application circuits shown in this document are provided for reference purposes only. Thorough evaluation is required, especially at the mass-production design stage.

Toshiba does not grant any license to any industrial property rights by providing these examples of application circuits.

**5. Test Circuits**

Components in the test circuits are used only to obtain and confirm the device characteristics. These components and circuits are not guaranteed to prevent malfunction or failure from occurring in the application equipment.

**IC Usage Considerations****Notes on handling of ICs**

- (1) The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded, even for a moment. Do not exceed any of these ratings. Exceeding the rating(s) may cause device breakdown, damage or deterioration, and may result in injury by explosion or combustion.
- (2) Use an appropriate power supply fuse to ensure that a large current does not continuously flow in the case of overcurrent and/or IC failure. The IC will fully break down when used under conditions that exceed its absolute maximum ratings, when the wiring is routed improperly or when an abnormal pulse noise occurs from the wiring or load, causing a large current to continuously flow and the breakdown can lead to smoke or ignition. To minimize the effects of the flow of a large current in the case of breakdown, appropriate settings, such as fuse capacity, fusing time and insertion circuit location, are required.
- (3) If your design includes an inductive load such as a motor coil, incorporate a protection circuit into the design to prevent device malfunction or breakdown caused by the current resulting from the inrush current at power ON or the negative current resulting from the back electromotive force at power OFF. IC breakdown may cause injury, smoke or ignition. Use a stable power supply with ICs with built-in protection functions. If the power supply is unstable, the protection function may not operate, causing IC breakdown. IC breakdown may cause injury, smoke or ignition.
- (4) Do not insert devices in the wrong orientation or incorrectly. Make sure that the positive and negative terminals of power supplies are connected properly. Otherwise, the current or power consumption may exceed the absolute maximum rating, and exceeding the rating(s) may cause device breakdown, damage or deterioration, and may result in injury by explosion or combustion.  
In addition, do not use any device inserted in the wrong orientation or incorrectly to which current is applied even just once.
- (5) Carefully select external components (such as inputs and negative feedback capacitors) and load components (such as speakers), for example, power amp and regulator.  
If there is a large amount of leakage current such as from input or negative feedback condenser, the IC output DC voltage will increase. If this output voltage is connected to a speaker with low input withstand voltage, overcurrent or IC failure may cause smoke or ignition. (The overcurrent may cause smoke or ignition from the IC itself.) In particular, please pay attention when using a Bridge Tied Load (BTL) connection-type IC that inputs output DC voltage to a speaker directly.

**Points to remember on handling of ICs****•Over current detection Circuit**

Overcurrent detection circuits (referred to as current limiter circuits) do not necessarily protect ICs under all circumstances. If the overcurrent detection circuits operate against the overcurrent, clear the overcurrent status immediately.

Depending on the method of use and usage conditions, exceeding absolute maximum ratings may cause the overcurrent detection circuit to operate improperly or IC breakdown may occur before operation. In addition, depending on the method of use and usage conditions, if overcurrent continues to flow for a long time after operation, the IC may generate heat resulting in breakdown.

**•Thermal Shutdown Circuit**

Thermal shutdown circuits do not necessarily protect ICs under all circumstances. If the thermal shutdown circuits operate against the over-temperature, clear the heat generation status immediately.

Depending on the method of use and usage conditions, exceeding absolute maximum ratings may cause the thermal shutdown circuit to operate improperly or IC breakdown to occur before operation.

**•Heat Radiation Design**

When using an IC with large current flow such as power amp, regulator or driver, design the device so that heat is appropriately radiated, in order not to exceed the specified junction temperature (T<sub>J</sub>) at any time or under any condition. These ICs generate heat even during normal use. An inadequate IC heat radiation design can lead to decrease in IC life, deterioration of IC characteristics or IC breakdown. In addition, when designing the device, take into consideration the effect of IC heat radiation with peripheral components.

**•Back-EMF**

When a motor rotates in the reverse direction, stops or slows abruptly, current flows back to the motor's power supply owing to the effect of back-EMF. If the current sink capability of the power supply is small, the device's motor power supply and output pins might be exposed to conditions beyond the absolute maximum ratings. To avoid this problem, take the effect of back-EMF into consideration in system design.

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